

United States Patent and Trademark Office



UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
|----------------------------------|---------------------------|----------------------|---------------------|------------------|
| 10/536,993 | 05/31/2005 | Toshitsugu Sakamoto | 8017-1169 | 9950 |
| 466 YOUNG & TH | 7590 01/18/200 IOMPSON | EXAMINER | | |
| 745 SOUTH 23 | | CRUZ, LESLIE PILAR | | |
| 2ND FLOOR ARLINGTON, VA 22202 | | | ART UNIT | PAPER NUMBER |
| inchi (oron) | | | 2826 | |
| | | | | |
| SHORTENED STATUTOR | RY PERIOD OF RESPONSE | MAIL DATE | DELIVERY MODE | |
| 3 MONTHS | | 01/18/2007 | PAPER | |

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

| | Application No. | Applicant(s) | |
|---|---|--|--|
| | 10/536,993 | SAKAMOTO ET AL. | |
| Office Action Summary | Examiner | Art Unit | |
| | Leslie P. Cruz | 2826 | |
| The MAILING DATE of this communication app Period for Reply | ears on the cover sheet with the c | orrespondence address | |
| A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication If NO period for reply is specified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). | ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin vill apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE | N. nely filed the mailing date of this communication. D (35 U.S.C. § 133). | |
| Status | | | |
| Responsive to communication(s) filed on 10 O This action is FINAL. 2b) ☐ This Since this application is in condition for alloware closed in accordance with the practice under E | action is non-final. nce except for formal matters, pro | | |
| Disposition of Claims | | | |
| 4) Claim(s) 1-10,20 and 21 is/are pending in the a 4a) Of the above claim(s) is/are withdray 5) Claim(s) is/are allowed. 6) Claim(s) 1-10,20 and 21 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o Application Papers 9) The specification is objected to by the Examine 10) The drawing(s) filed on 31 May 2005 is/are: a) Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine | wn from consideration. r election requirement. r. ⊠ accepted or b) □ objected to drawing(s) be held in abeyance. Selion is required if the drawing(s) is objected to drawi | e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d). | |
| , <u> </u> | | | |
| Priority under 35 U.S.C. § 119 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureau * See the attached detailed Office action for a list | s have been received. s have been received in Applicat rity documents have been receive u (PCT Rule 17.2(a)). | ion No ed in this National Stage | |
| Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 05/31/2005. | 4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other: | ate | |

DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of Group I, drawn to a semiconductor device in the reply filed on 10/10/2006 is acknowledged. Accordingly, pending in the Office Action are claims 1-10, 20 and 21.

Priority

Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Information Disclosure Statement

The Information Disclosure Statement filed on 05/31/2005 has been considered.

Oath/Declaration

The oath or declaration filed on 05/31/2005 is acceptable.

Drawings

The drawings filed on 05/31/2005 are acceptable.

Claim Objections

Art Unit: 2826

Claim 1 is objected to because of the following informalities: a prefix (e.g. "a") should be in front of "connection plug" in line 2. Appropriate correction is required.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 3, 5, 7, 9 & 20 are rejected under 35 U.S.C. 102(b) as being anticipated by Awano (US 2002/0163079 A1).

With respect to claim 1, Awano (e.g. Figs. 1, 4, 5D & 6) discloses a semiconductor device comprising a connection plug [15] wherein a nanomaterial [16] is substantially uniformly disposed in a section of the connection plug formed from a metal [18].

With respect to claim 3, Awano discloses the semiconductor according to claim 1.

Awano further discloses the nanomaterial is a fibrous carbon nanomaterial or a particle-like carbon nanomaterial.

With respect to claim 5, Awano discloses the semiconductor according to claim 1.

Awano further discloses the nanomaterial is oriented substantially perpendicularly to a substrate [0075].

Art Unit: 2826

With respect to claim 7, Awano discloses the semiconductor according to claim 1.

Awano (e.g. Figs. 1 & 4) further discloses the nanomaterial is provided in the whole connection plug.

With respect to claim 9, Awano discloses the semiconductor according to claim 1. The limitation "the metal is formed by an MOCVD method or a plating method" is a product by process limitation and is not given patentable weight. Therefore, claim 9 is not patentably distinguishable over the Awano reference. See note below.

With respect to claim 20, Awano discloses the semiconductor according to claim 1.

Awano (e.g. Figs. 1, 4, 5D & 6) further discloses the connection plug is formed from a metal [18] containing a nanomaterial [paragraph 0076]. The limitation "metal is formed by a plating method which involves a plating liquid" is a product by process limitation and is not given patentable weight. Therefore, claim 20 is not patentable distinguishable over the Awano reference. See note below.

Claims 2, 4, 6, 8, 10 & 21 are rejected under 35 U.S.C. 102(e) as being anticipated by Haase (US 2003/0211724 A1).

With respect to claim 2, Haase (e.g. Figs. 1 & 2) discloses a semiconductor device comprising an interconnection [24] wherein nanomaterial [32] is substantially uniformly formed on a bottom surface of the interconnection [30] formed from a metal [paragraph 0015].

With respect to claim 4, Haase discloses the semiconductor device according to claim 2. Haase further discloses the nanomaterial is a fibrous carbon nanomaterial or a particle-like carbon nanomaterial [paragraph 0015].

Art Unit: 2826

With respect to claim 6, Haase discloses the semiconductor device according to claim 2. Haase (e.g. Figs. 1 & 2) further discloses the nanomaterial is oriented substantially perpendicular to a substrate [16].

With respect to claim 8, Haase discloses the semiconductor device according to claim 2. Haase (e.g. Figs. 1 & 2) further discloses the nanomaterial is provided up to the vicinity of a top surface of the interconnection.

With respect to claim 10, Haase discloses the semiconductor device according to claim 2. The limitation "the metal is formed by an MOCVD method or a plating method" is a product by process limitation and is not given patentable weight. Therefore, claim 10 is not patentably distinguishable over the Haase reference. See note below.

With respect to claim 21, Haase discloses the semiconductor according to claim 2. Haase further discloses the interconnection is formed from a metal containing a nanomaterial [paragraph 0015]. The limitation "metal is formed by a plating method which involves a plating liquid" is a product by process limitation and is not given patentable weight. Therefore, claim 20 is not patentable distinguishable over the Haase reference. See note below.

Product by Process

Note that a "product by process" claim is directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See also In re Brown, 173 USPQ 685; In re Luck, 177 USPQ 523; In re Fessmann, 180 USPQ 324; In re Avery, 186 USPQ 161; In re Wertheim, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); and In re Marosi et al., 218 USPQ 289, all of which make it clear that it is the patentability of the final product per

Art Unit: 2826

se which must be determined in a "product by process" claim, and not the patentability of the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in "product by process" claims or not. Note that applicant has the burden of proof in such cases, as the above case law makes clear. See also MPEP § 706.03(e).

Telephone/Fax Information

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Leslie P. Cruz whose telephone number is (571) 272-8599. The examiner can normally be reached on Monday-Friday 9:00-5:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisors, Wael Fahmy and Bob Pascal can be reached on (571) 272-1705 and (571) 272-1769, respectively. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Art Unit: 2826

lpc